

L. Number	Hits	Search Text	DB	Time stamp
22	3	257/667,787.ccls. and dummy adj pads and (chip die IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 17:40
23	2	257/667,787.ccls. and dummy adj pads and pitch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 17:42
24	0	257/670,669,674.ccls. and dummy adj pads and pitch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 17:42
25	5	257/668.ccls. and dummy adj pads and pitch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 17:44
26	49	dummy adj pads and pitch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 17:50
27	161	dummy adj pads and (IC die chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:04
28	2	("6268644").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:07
29	0	yuan-po-hao.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:07
30	38	wu-chi-chuan.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:10
31	1	chen-chih-shun.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:13
32	2680	(IC chip die) and dum\$4 and pitch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:22
33	2	("6297078").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:23
34	11	("4928162" "5045919" "5296743" "5457340" "5508556" "5563446" "5565709" "5596227" "5684332" "5780772" "5843808").PN.	USPAT	2003/09/20 18:22
35	2	("5825081").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:28

36	12	257/671,674.ccls. and dum\$4 and (IC die chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:30
37	25	438/123-124.ccls. and dum\$4 and (IC die chip) and pit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:34
38	0	438/6134.ccls. and dum\$4 and (IC die chip) and pit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:34
39	14	438/613.ccls. and dum\$4 and (IC die chip) and pit\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/20 18:34